502634869 01/14/2014

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT2681477

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
YURI BILENKO	12/11/2013
MICHAEL SHUR	12/11/2013
REMIGIJUS GASKA	12/10/2013

RECEIVING PARTY DATA

Name:	Sensor Electronic Technology, Inc.
Street Address:	1195 Atlas Road
City:	Columbia
State/Country:	SOUTH CAROLINA
Postal Code:	29209

PROPERTY NUMBERS Total: 2

Property Type	Number
Application Number:	14102538
Application Number:	61735648

CORRESPONDENCE DATA

Fax Number: (518)514-1360 **Phone**: 5187553658

Email: national@labattlaw.com

Correspondence will be sent via US Mail when the email attempt is unsuccessful.

Correspondent Name: JOHN W LABATT Address Line 1: PO BOX 630

Address Line 4: VALATIE, NEW YORK 12184

ATTORNEY DOCKET NUMBER:	SETI-0106-US
NAME OF SUBMITTER:	JOHN W LABATT
Signature:	/John LaBatt/
	PATENT

502634869 REEL: 031966 FRAME: 0001

Date:	01/14/2014
Total Attachments: 4 source=SETI-0106_Assignment_Signed#pa source=SETI-0106_Assignment_Signed#pa source=SETI-0106_Assignment_Signed#pa source=SETI-0106_Assignment_Signed#pa	ge2.tif ge3.tif

PATENT REEL: 031966 FRAME: 0002

ASSIGNMENT OF PATENT APPLICATION

FOR GOOD AND VALUABLE CONSIDERATION,

We, the undersigned (each) have agreed and hereby agree to assign for good and valuable consideration, receipt of which is hereby expressly acknowledged, and do hereby sell, assign and transfer unto

Sensor Electronic Technology, Inc.

a corporation organized under the laws of the state of New York as Assignee, and its successors, assigns and legal representatives, the entire right, title and interest, for all countries in and to certain inventions relating to

Thermal Management Structure with Integrated Heat Sink

described in a U.S. Provisional Application No. 61735648, filed on 11 December 2012, and in an application for Letters Patent of the United States, identified as Attorney Docket No. SETI-0106-US, at LaBatt, LLC, PO Box 630, Valatie, NY 12184, and the invention(s) and improvement(s) set forth therein, and any and all continuations, continuations-in-part, divisionals, and renewals of and substitutes for either or both of the applications for said Letters Patent, and all the rights and privileges under any and all Letters Patent that may be granted therefor in any country, and any reissues, or reexaminations, or extensions of said Letters Patent. We request that any and all Letters Patent for said inventions be issued to said Assignee, its successors, assigns and legal representatives, or to such nominees as it may designate.

We agree that, when requested, we will, without charge to said Assignee but at its expense, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable or convenient for securing and maintaining patents for said inventions in any and all countries and for vesting title thereto in said Assignee, its successors, assigns and legal representatives or nominees.

We authorize and empower the Assignee, its successors, assigns and legal representatives or nominees, to invoke and claim for any application for patent or other form of protection for said inventions filed by it or them, the benefit of the right of priority provided by the International Convention for the Protection of Industrial Property, as amended, or by any convention which may henceforth be substituted for it, and to invoke and claim such right of priority without further written or oral authorization from us.

We hereby consent that a copy of this assignment shall be deemed a full legal and formal equivalent of any assignment, consent to file or like document which may be required in any country for any purpose and more particularly in proof of the right of the Assignee or nominee to claim the aforesaid benefit of the right of priority provided by the International convention which may henceforth be substituted for it.

Patent Application Assignment

Page 1 of 2

We covenant with the Assignee, its successors, assigns and legal representatives, that the rights and property herein conveyed are free and clear of any encumbrance, and that we have full right to convey the same as herein expressed.

IN WITNESS WHEREOF, we have hereunto signed our name(s) on the day and year set forth below.

Signature:	< period	Date: 12/11/201
	Yuri Bilenko	
Signature:	Luh-	12/11/2013 Date:
	Michael Shur	
Signature:	Damialius Caska	Date:
	Remigijus Gaska	

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Signature:		Date:	
	Michael Shur		a e r a
Signature	Remigijus Gaska	Date: <u> </u>	1/2013

Patent Application Assignment

RECORDED: 01/14/2014

Page 2 of 2